



PRESS RELEASE

BE Semiconductor Industries N.V. Announces Q3-2022 Conference Call and Webcast Details

Duiven, the Netherlands, October 13, 2022 - BE Semiconductor Industries N.V. ("the Company" or "Besì"), (Euronext Amsterdam: BESI; OTC: BESIY), a leading manufacturer of assembly equipment for the semiconductor industry, will issue its results for the third quarter ended September 30, 2022, on Thursday, October 20, 2022 at 7.00 a.m. CET (1.00 a.m. EDT). A conference call to discuss the Company's 2022 third quarter results will be held on Thursday October 20, 2022, at 4.00 pm CET (10.00 am EDT).

To access the conference call, interested parties can pre-register using this [link](#) to receive dial-in numbers and a personal PIN which are required to access the conference call. The audio webcast can be accessed via the Company's website: www.besi.com, where also a replay will be available shortly after the call.

About Besì

Besì is a leading supplier of semiconductor assembly equipment for the global semiconductor and electronics industries offering high levels of accuracy, productivity and reliability at a low cost of ownership. The Company develops leading edge assembly processes and equipment for leadframe, substrate and wafer level packaging applications in a wide range of end-user markets including electronics, mobile internet, cloud server, computing, automotive, industrial, LED and solar energy. Customers are primarily leading semiconductor manufacturers, assembly subcontractors and electronics and industrial companies. Besì's ordinary shares are listed on Euronext Amsterdam (symbol: BESI). Its Level 1 ADRs are listed on the OTC markets (symbol: BESIY) and its headquarters are located in Duiven, the Netherlands. For more information, please visit our website at www.besi.com.

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